

1.6X0.8mm PHOTOTRANSISTOR

Part Number: AP1608P1C

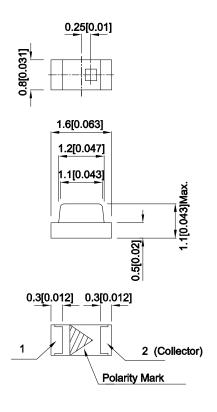
Features

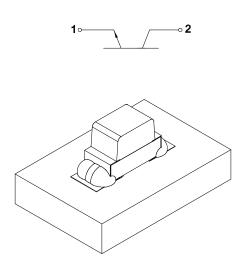
- 1.6mmX0.8mm SMD LED, 1.1mm thickness.
- Mechanically and spectrally matched to the infrared emitting LED lamp.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

Made with silicon phototransistor chips.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 4.The device has a single mounting surface. The device must be mounted according to the specifications.

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Electrical / Optical Characteristics at TA=25°C

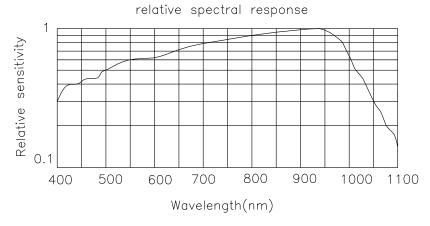
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
VBR CEO	Collector-to-Emitter Breakdown Voltage	30			V	Ic=100uA Ee=0mW/cm ²
VBR ECO	Emitter-to-Collector Breakdown Voltage	5			V	IE=100uA Ee=0mW/cm ²
VCE (SAT)	Collector-to-Emitter Saturation Voltage			0.8	V	Ic=2mA Ee=20mW/cm ²
I CEO	Collector Dark Current			100	nA	Vce=10V Ee=0mW/cm ²
TR	Rise Time (10% to 90%)		15		us	VcE = 5V Ic=1mA RL=1000Ω
TF	Fall Time (90% to 10%)		15		us	
I (ON)	On State Collector Current	0.1	0.3		mA	VCE = 5V Ee=1mW/cm ² λ =940nm
λ0.1	Range of spectral bandwidth	420		1120	nm	
λр	Wavelength of peak sensitivity		940		nm	
201/2	Angle of half sensitivity		150		deg	

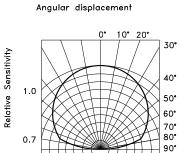
Absolute Maximum Ratings at TA=25°C

Parameter	Max.Ratings			
Collector-to-Emitter Voltage	30V			
Emitter-to-Collector Voltage	5V			
Power Dissipation at (or below) 25°C Free Air Temperature	100mW			
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

Note:

^{1.} Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.





Relative radiant sensitivity vs.

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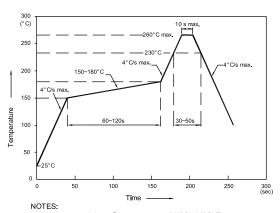
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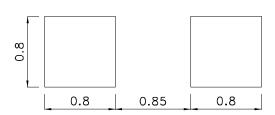
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

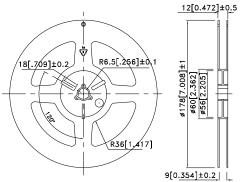


- 1. We recommend the reflow temperature 245° C(+/-5° C). The maximum soldering temperature should be limited to 260° C.
- 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specifications (Units: mm)

TAPE

4.0±0.1

2.0±0.1

4.0±0.1

Ø1.5±0.1

1.3±0.1

Ø0.6 Typ.

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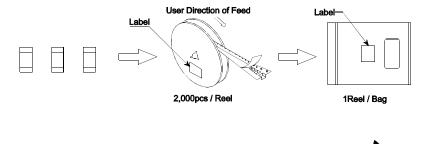
A-A SECTION

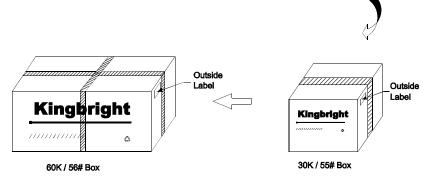
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PACKING & LABEL SPECIFICATIONS

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